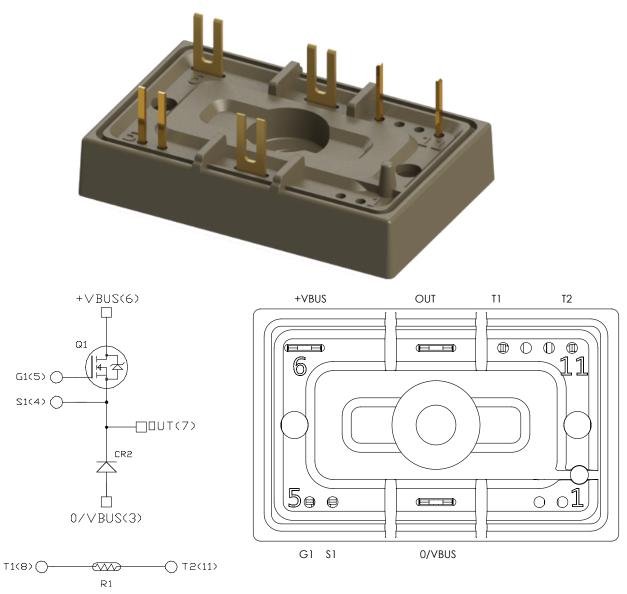
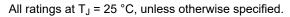


Buck Chopper SiC MOSFET Power Module

Product Overview

The MSCSM120SKM31CTBL1NG device is a 1200 V, 79 A buck chopper silicon carbide (SiC) MOSFET power module.





Caution: These devices are sensitive to electrostatic discharge. Proper handling procedures must be followed.

Features

The following are the key features of MSCSM120SKM31CTBL1NG device:

- SiC Power MOSFET
 - Low R_{DS(on)}
 - High speed switching
- SiC Schottky Diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature independent switching behavior
 - Positive temperature coefficient on V_F
- · Very low stray inductance
- Ultra-low weight and profile
- Kelvin source for easy drive
- Si_3N_4 substrate with thick copper for improved thermal performance
- Internal thermistor for temperature monitoring
- Extended temperature range

Benefits

The following are the benefits of MSCSM120SKM31CTBL1NG device:

- High efficiency converter
- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- · Low junction-to-case thermal resistance
- · Low profile
- RoHS Compliant
- Solderable terminals both for power and signal for easy PCB mounting
- Very integrated power conversion system

Application

The following are the applications of MSCSM120SKM31CTBL1NG device:

- High reliability power systems
- High Efficiency AC/DC and DC/AC converters
- Motor control

1. Electrical Specifications

This section provides the electrical specifications of the MSCSM120SKM31CTBL1NG device.

1.1 SiC MOSFET Characteristics (Per SiC MOSFET)

The following table lists the absolute maximum ratings of MSCSM120SKM31CTBL1NG device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter	Parameter		Unit
V _{DSS}	Drain-Source voltage	ain-Source voltage		V
I _D	Continuous drain current	tinuous drain current $\frac{T_{H} = 25 \text{ °C}}{T_{H} = 80 \text{ °C}} \qquad 6$		А
I _{DM}	Pulsed drain current	ed drain current		
V _{GS}	Gate-Source voltage	te-Source voltage		V
R _{DS(on)}	Drain-Source ON resistance		31	mΩ
P _D	Power dissipation	T _H = 25 °C	310	W

The following table lists the electrical characteristics of MSCSM120SKM31CTBL1NG device.

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V · · · · · · · · · · · · · · · · · ·		_	10	100	μA
R _{DS(on)}	Drain–Source on resistance	V _{GS} = 20 V I _D = 40 A	T _J = 25 °C T _J = 175 °C		25 40	31 —	mΩ
V _{GS(th)}	Gate threshold voltage	$V_{GS} = V_{DS}$ $I_D = 1 \text{ mA}$		1.8	2.8	—	V
I _{GSS}	Gate–Source leakage current	V _{GS} = 20 V V _{DS} = 0 V				150	nA

Table 1-2. Electrical Characteristics

Electrical Specifications

The following table lists the dynamic characteristics of MSCSM120SKM31CTBL1NG device.

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
C _{iss}	Input capacitance	V _{GS} = 0 V V _{DS} = 1000 V		-	3020	-	pF
C _{oss}	Output capacitance			—	270	-	
C _{rss}	Reverse transfer capacitance	f = 1 MHz		_	25	_	-
Qg	Total gate charge	V _{GS} = -5 V/20 V		_	232	_	nC
Qgs	Gate-Source charge	V _{Bus} = 800 V		_	41	_	
Q _{gd}	Gate-Drain charge	I _D = 40 A		-	50	-	
T _{d(on)}	Turn-on delay time	$V_{GS} = -5 V/20 V$ $V_{Bus} = 600 V$ $I_{D} = 50 A$ $R_{Gon} = 8 \Omega$ $R_{Goff} = 4.7 \Omega$		_	30	_	ns
Tr	Rise time			_	30	-	
T _{d(off)}	Turn-off delay time			_	50	_	
Τ _f	Fall time				25	_	
Eon	Turn-on energy	V _{GS} = -5 V/20 V	T _J = 150 °C	_	0.99	_	mJ
Eoff	Turn-off energy	V _{Bus} = 600 V I _D = 50 A R _{Gon} = 8 Ω R _{Goff} = 4.7 Ω	TJ = 150 °C	_	0.66	-	
RGint	Internal gate resistance			-	0.88	-	Ω
R _{thJH}	Junction-to-heatsink thermal resistance $\lambda = 3.4 \text{ W/mK}$				0.483	-	°C/W

Table 1-3. Dynamic Characteristics

The following table lists the body diode ratings and characteristics of MSCSM120SKM31CTBL1NG device.

Table 1-4. Body Diode Ratings and Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Мах	Unit
V_{SD}	Diode forward voltage	V _{GS} = 0 V		4	—	V
		I _{SD} = 40 A				
		V_{GS} = -5 V		4.2	—	
		I _{SD} = 40 A				
t _{rr}	Reverse recovery time	I _{SD} = 40 A		90	—	ns
Q _{rr}	Reverse recovery charge	$V_{GS} = -5 V$		550	—	nC
Irr	Reverse recovery current	V _R = 800 V		13.5	—	А
		di _F /dt = 1000 A/µs				

1.2 SiC Diode Ratings and Characteristics (Per SiC Diode)

The following table lists the SiC diode ratings and characteristics of MSCSM120SKM31CTBL1NG device.

Symbol	Characteristic	Test Conditi	ons		Min	Тур	Max	Unit
V _{RRM}	Peak repetitive reverse vo	oltage	Itage			—	1200	V
I _{RM}	Reverse leakage current	V _R = 1200 V		T _J = 25 °C	_	10	200	μA
				T _J = 175 °C	_	250	_	
I _F	DC forward current		T _H = 100 °C		_	50	_	А
V _F	Diode forward voltage $I_F = 50 A$			T _J = 25 °C	_	1.5	1.8	V
				T _J = 175 °C	_	2.1	—	
Q _C	Total capacitive charge	V _R = 600 V	V _R = 600 V		_	224	_	nC
С	Total capacitance	f = 1 MHz			_	246	_	pF
		V _R = 400 V						
		f = 1 MHz			_	182	_	
		V _R = 800 V						
R _{thJH}	Junction-to-heatsink therr resistance	nal $\lambda_{\text{paste}} = 3.4 \text{ W/mK}$		—	0.635	—	°C/W	

Table 1-5. SiC Diode Ratings and Characteristics

1.3 Thermal and Package Characteristics

The following table lists the thermal and package characteristics of the MSCSM120SKM31CTBL1NG device.

Table 1-6. Thermal and Package Characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
V _{ISOL}	RMS isolation voltage, any terminal to case t = 1 min, 50 Hz/60 Hz			2500		—	V
TJ	Operating junction temperature range			-55		175	°C
T _{JOP}	Recommended junction temperature under switching conditions			-55	—	T _{Jmax} –25	
T _{STG}	Storage case temperature			-55		125	
T _C	Operating case temperature			-55		125	
Torque	Mounting torque	Nounting torque To heatsink M4		1.5		2	N.m
Wt	Package weight			-	13.5	_	g

Electrical Specifications

The following table lists the temperature sensor NTC of the MSCSM120SKM31CTBL1NG device.

Table 1-7. Temperature Sensor NTC

Symbol	Characteristic		Min	Тур	Max	Unit
R ₂₅	Resistance at 25°C		—	50	—	kΩ
$\Delta R_{25}/R_{25}$	—		—	5	_	%
B _{25/85}	T ₂₅ = 298.15 K		_	3952	_	К
ΔΒ/Β	—	T _C = 100°C	_	4	_	%

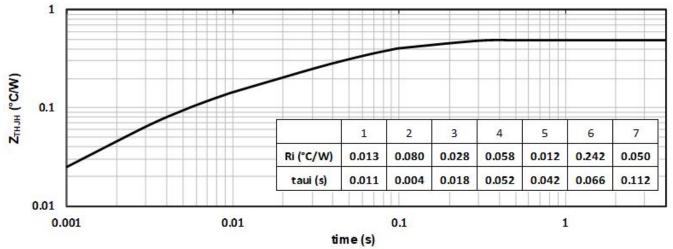
 $R_{T} = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$ T: Thermistor temperature R_T: Thermistor value at T

Note: See APT0406—Using NTC Temperature Sensor Integrated into Power Module for more information.

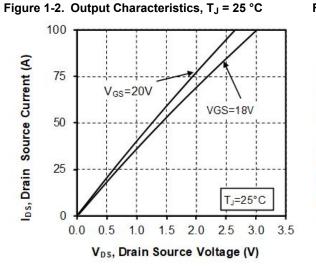
1.4 Typical SiC MOSFET Performance Curve

This section shows the typical SiC MOSFET performance curves of the MSCSM120SKM31CTBL1NG device.

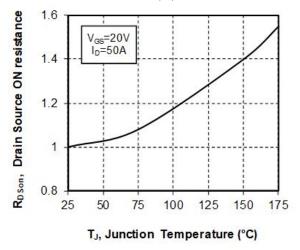




Electrical Specifications







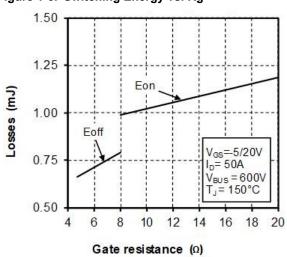
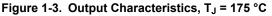


Figure 1-6. Switching Energy vs. Rg



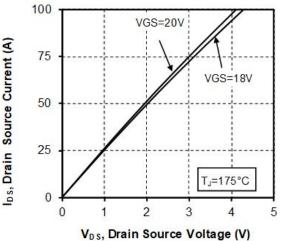
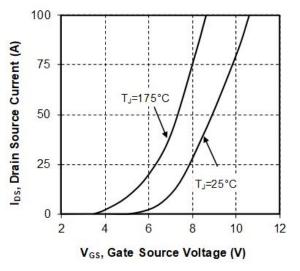
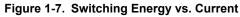
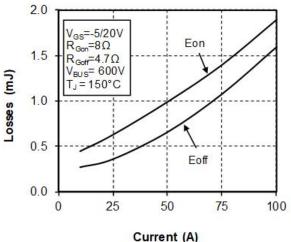


Figure 1-5. Transfer Characteristics







Electrical Specifications

200

250

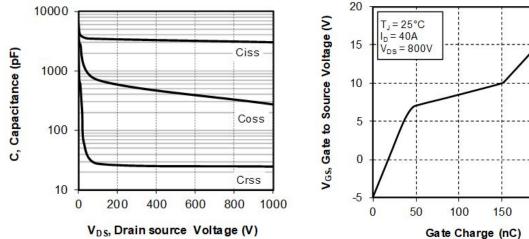
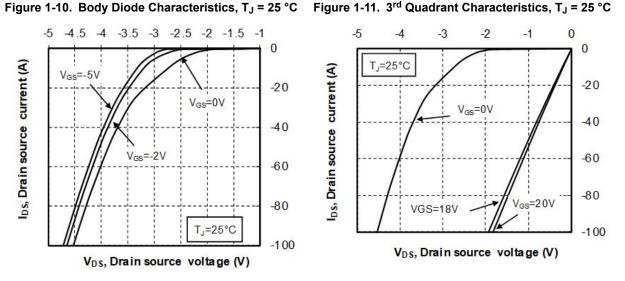


Figure 1-8. Capacitance vs. Drain Source Voltage





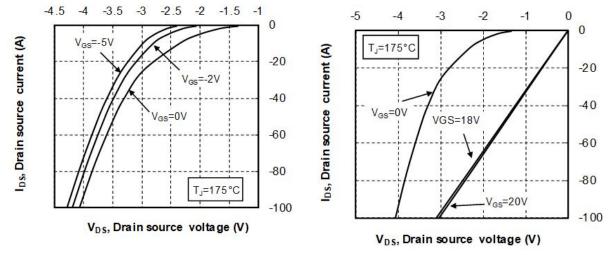


Figure 1-9. Gate Charge vs. Gate Source Voltage

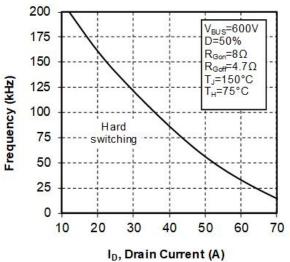
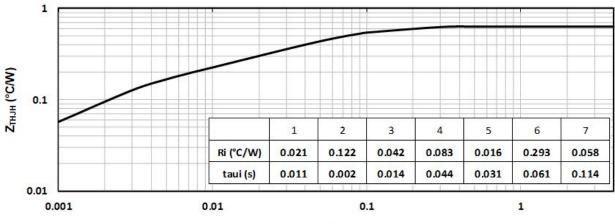


Figure 1-14. Operating Frequency vs Drain Current

1.5 Typical SiC Diode Performance Curves

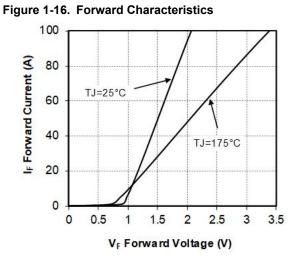
This section shows the typical SiC diode performance curves of the MSCSM120SKM31CTBL1NG device.

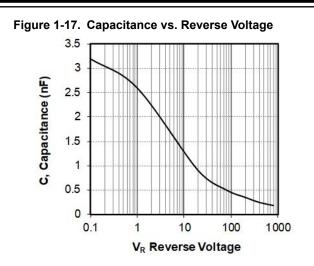




time (s)

Electrical Specifications





Package Specifications

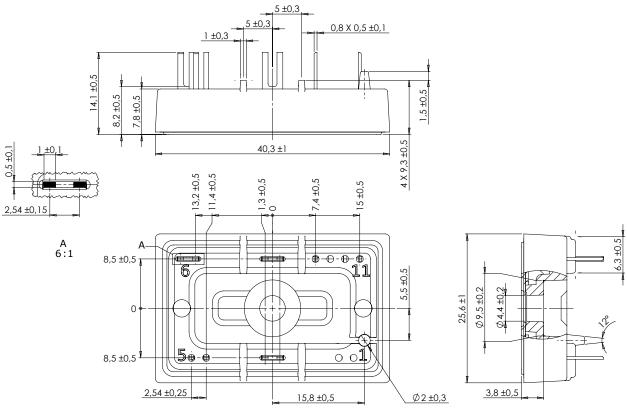
2. Package Specifications

The following section shows the package specification of the MSCSM120SKM31CTBL1NG device.

2.1 Package Outline

The following figure shows the package outline drawing of the MSCSM120SKM31CTBL1NG device. The dimensions in the following figure are in millimeters.

Figure 2-1. Package Outline Drawing



3. Revision History

Revision	Date	Description
A	07/2021	Initial Revision

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<u>25.330.4753.1</u> <u>25.330.5253.1</u> <u>25.334.3253.1</u> <u>25.334.3353.1</u> <u>25.350.2053.0</u> <u>25.352.4753.1</u> <u>25.522.3253.0</u> <u>T483C</u> <u>T484C</u> <u>T485F</u>
<u>T512F-YEB</u> <u>T513F</u> <u>T514F</u> <u>T554</u> <u>T612FSE</u> <u>25.161.3453.0</u> <u>25.179.2253.0</u> <u>25.194.3253.0</u> <u>25.325.1253.1</u> <u>25.326.4253.1</u> <u>25.330.0953.1</u>
<u>25.332.4353.1</u> <u>25.350.1653.0</u> <u>25.350.2453.0</u> <u>25.352.1453.0</u> <u>25.352.1653.0</u> <u>25.352.2453.0</u> <u>25.352.5453.1</u> <u>25.522.3353.0</u> <u>25.602.4053.0</u>
25.640.5053.0